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### Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |   |
|--------------------------------|---|
| Product Status                 | Obsolete  |
| Number of LABs/CLBs            | 185000  |
| Number of Logic Elements/Cells | 490000  |
| Total RAM Bits                 | 46080000  |
| Number of I/O                  | 432   |
| Number of Gates                | -   |
| Voltage - Supply               | 0.87V ~ 0.93V   |
| Mounting Type                  | Surface Mount   |
| Operating Temperature          | 0°C ~ 85°C (TJ)   |
| Package / Case                 | 1152-BBGA, FCBGA  |
| Supplier Device Package        | 1152-FBGA (35x35)   |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/intel/5sgxma5k3f35c2n">https://www.e-xfl.com/product-detail/intel/5sgxma5k3f35c2n</a> |

**Table 1. Stratix V GX and GS Commercial and Industrial Speed Grade Offering <sup>(1), (2), (3)</sup> (Part 2 of 2)**

| Transceiver Speed Grade  | Core Speed Grade |         |     |     |         |         |                    |     |
|--------------------------|------------------|---------|-----|-----|---------|---------|--------------------|-----|
|                          | C1               | C2, C2L | C3  | C4  | I2, I2L | I3, I3L | I3YY               | I4  |
| 3<br>GX channel—8.5 Gbps | —                | Yes     | Yes | Yes | —       | Yes     | Yes <sup>(4)</sup> | Yes |

**Notes to Table 1:**

- (1) C = Commercial temperature grade; I = Industrial temperature grade.  
 (2) Lower number refers to faster speed grade.  
 (3) C2L, I2L, and I3L speed grades are for low-power devices.  
 (4) I3YY speed grades can achieve up to 10.3125 Gbps.

Table 2 lists the industrial and commercial speed grades for the Stratix V GT devices.

**Table 2. Stratix V GT Commercial and Industrial Speed Grade Offering <sup>(1), (2)</sup>**

| Transceiver Speed Grade                            | Core Speed Grade |     |     |     |
|--|------------------|-----|-----|-----|
|  | C1               | C2  | I2  | I3  |
| 2<br>GX channel—12.5 Gbps<br>GT channel—28.05 Gbps | Yes              | Yes | —   | —   |
| 3<br>GX channel—12.5 Gbps<br>GT channel—25.78 Gbps | Yes              | Yes | Yes | Yes |

**Notes to Table 2:**

- (1) C = Commercial temperature grade; I = Industrial temperature grade.  
 (2) Lower number refers to faster speed grade.

**Absolute Maximum Ratings**

Absolute maximum ratings define the maximum operating conditions for Stratix V devices. The values are based on experiments conducted with the devices and theoretical modeling of breakdown and damage mechanisms. The functional operation of the device is not implied for these conditions.



Conditions other than those listed in Table 3 may cause permanent damage to the device. Additionally, device operation at the absolute maximum ratings for extended periods of time may have adverse effects on the device.

**Table 3. Absolute Maximum Ratings for Stratix V Devices (Part 1 of 2)**

| Symbol              | Description  | Minimum | Maximum | Unit |
|---------------------|--|---------|---------|------|
| V <sub>CC</sub>     | Power supply for core voltage and periphery circuitry                  | −0.5    | 1.35    | V    |
| V <sub>CCPT</sub>   | Power supply for programmable power technology                         | −0.5    | 1.8     | V    |
| V <sub>CCPGM</sub>  | Power supply for configuration pins                                    | −0.5    | 3.9     | V    |
| V <sub>CC_AUX</sub> | Auxiliary supply for the programmable power technology                 | −0.5    | 3.4     | V    |
| V <sub>CCBAT</sub>  | Battery back-up power supply for design security volatile key register | −0.5    | 3.9     | V    |
| V <sub>CCPD</sub>   | I/O pre-driver power supply  | −0.5    | 3.9     | V    |
| V <sub>CCIO</sub>   | I/O power supply   | −0.5    | 3.9     | V    |

### I/O Pin Leakage Current

Table 9 lists the Stratix V I/O pin leakage current specifications.

**Table 9. I/O Pin Leakage Current for Stratix V Devices <sup>(1)</sup>**

| Symbol   | Description        | Conditions                          | Min | Typ | Max | Unit          |
|----------|--------------------|-------------------------------------|-----|-----|-----|---------------|
| $I_I$    | Input pin          | $V_I = 0 \text{ V to } V_{CCIOMAX}$ | -30 | —   | 30  | $\mu\text{A}$ |
| $I_{OZ}$ | Tri-stated I/O pin | $V_O = 0 \text{ V to } V_{CCIOMAX}$ | -30 | —   | 30  | $\mu\text{A}$ |

**Note to Table 9:**

(1) If  $V_O = V_{CCIO}$  to  $V_{CCIOMAX}$ , 100  $\mu\text{A}$  of leakage current per I/O is expected.

### Bus Hold Specifications

Table 10 lists the Stratix V device family bus hold specifications.

**Table 10. Bus Hold Parameters for Stratix V Devices**

| Parameter               | Symbol            | Conditions                                     | V <sub>CCIO</sub> |      |       |      |       |      |       |      |       |      | Unit |
|-------------------------|-------------------|--|-------------------|------|-------|------|-------|------|-------|------|-------|------|------|
|                         |                   |  | 1.2 V             |      | 1.5 V |      | 1.8 V |      | 2.5 V |      | 3.0 V |      |      |
|                         |                   |  | Min               | Max  | Min   | Max  | Min   | Max  | Min   | Max  | Min   | Max  |      |
| Low sustaining current  | I <sub>SUSL</sub> | V <sub>IN</sub> > V <sub>IL</sub><br>(maximum) | 22.5              | —    | 25.0  | —    | 30.0  | —    | 50.0  | —    | 70.0  | —    | μA   |
| High sustaining current | I <sub>SUSH</sub> | V <sub>IN</sub> < V <sub>IH</sub><br>(minimum) | −22.5             | —    | −25.0 | —    | −30.0 | —    | −50.0 | —    | −70.0 | —    | μA   |
| Low overdrive current   | I <sub>ODL</sub>  | 0V < V <sub>IN</sub> < V <sub>CCIO</sub>       | —                 | 120  | —     | 160  | —     | 200  | —     | 300  | —     | 500  | μA   |
| High overdrive current  | I <sub>ODH</sub>  | 0V < V <sub>IN</sub> < V <sub>CCIO</sub>       | —                 | −120 | —     | −160 | —     | −200 | —     | −300 | —     | −500 | μA   |
| Bus-hold trip point     | V <sub>TRIP</sub> | —  | 0.45              | 0.95 | 0.50  | 1.00 | 0.68  | 1.07 | 0.70  | 1.70 | 0.80  | 2.00 | V    |

### On-Chip Termination (OCT) Specifications

If you enable OCT calibration, calibration is automatically performed at power-up for I/Os connected to the calibration block. Table 11 lists the Stratix V OCT termination calibration accuracy specifications.

**Table 11. OCT Calibration Accuracy Specifications for Stratix V Devices <sup>(1)</sup> (Part 1 of 2)**

| Symbol             | Description   | Conditions                                     | Calibration Accuracy |          |                |          | Unit |
|--------------------|---|--|----------------------|----------|----------------|----------|------|
|                    |   |  | C1                   | C2,I2    | C3,I3,<br>I3YY | C4,I4    |      |
| 25- $\Omega$ $R_S$ | Internal series termination with calibration (25- $\Omega$ setting) | $V_{CCIO} = 3.0, 2.5, 1.8, 1.5, 1.2 \text{ V}$ | $\pm 15$             | $\pm 15$ | $\pm 15$       | $\pm 15$ | %    |

**Table 11. OCT Calibration Accuracy Specifications for Stratix V Devices <sup>(1)</sup> (Part 2 of 2)**

| Symbol   | Description  | Conditions                                    | Calibration Accuracy |            |                |            | Unit |
|--|--|---|----------------------|------------|----------------|------------|------|
|  |  |   | C1                   | C2,I2      | C3,I3,<br>I3YY | C4,I4      |      |
| 50-Ω R <sub>S</sub>                              | Internal series termination with calibration (50-Ω setting)                                      | V <sub>CCIO</sub> = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15                  | ±15        | ±15            | ±15        | %    |
| 34-Ω and 40-Ω R <sub>S</sub>                     | Internal series termination with calibration (34-Ω and 40-Ω setting)                             | V <sub>CCIO</sub> = 1.5, 1.35, 1.25, 1.2 V    | ±15                  | ±15        | ±15            | ±15        | %    |
| 48-Ω, 60-Ω, 80-Ω, and 240-Ω R <sub>S</sub>       | Internal series termination with calibration (48-Ω, 60-Ω, 80-Ω, and 240-Ω setting)               | V <sub>CCIO</sub> = 1.2 V                     | ±15                  | ±15        | ±15            | ±15        | %    |
| 50-Ω R <sub>T</sub>                              | Internal parallel termination with calibration (50-Ω setting)                                    | V <sub>CCIO</sub> = 2.5, 1.8, 1.5, 1.2 V      | -10 to +40           | -10 to +40 | -10 to +40     | -10 to +40 | %    |
| 20-Ω, 30-Ω, 40-Ω, 60-Ω, and 120-Ω R <sub>T</sub> | Internal parallel termination with calibration (20-Ω, 30-Ω, 40-Ω, 60-Ω, and 120-Ω setting)       | V <sub>CCIO</sub> = 1.5, 1.35, 1.25 V         | -10 to +40           | -10 to +40 | -10 to +40     | -10 to +40 | %    |
| 60-Ω and 120-Ω R <sub>T</sub>                    | Internal parallel termination with calibration (60-Ω and 120-Ω setting)                          | V <sub>CCIO</sub> = 1.2                       | -10 to +40           | -10 to +40 | -10 to +40     | -10 to +40 | %    |
| 25-Ω R <sub>S_left_shift</sub>                   | Internal left shift series termination with calibration (25-Ω R <sub>S_left_shift</sub> setting) | V <sub>CCIO</sub> = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15                  | ±15        | ±15            | ±15        | %    |

**Note to Table 11:**

(1) OCT calibration accuracy is valid at the time of calibration only.

Table 12 lists the Stratix V OCT without calibration resistance tolerance to PVT changes.

**Table 12. OCT Without Calibration Resistance Tolerance Specifications for Stratix V Devices (Part 1 of 2)**

| Symbol                      | Description  | Conditions                        | Resistance Tolerance |       |                 |        | Unit |
|-----------------------------|--|-----------------------------------|----------------------|-------|-----------------|--------|------|
|                             |  |                                   | C1                   | C2,I2 | C3, I3,<br>I3YY | C4, I4 |      |
| 25-Ω R, 50-Ω R <sub>S</sub> | Internal series termination without calibration (25-Ω setting) | V <sub>CCIO</sub> = 3.0 and 2.5 V | ±30                  | ±30   | ±40             | ±40    | %    |
| 25-Ω R <sub>S</sub>         | Internal series termination without calibration (25-Ω setting) | V <sub>CCIO</sub> = 1.8 and 1.5 V | ±30                  | ±30   | ±40             | ±40    | %    |
| 25-Ω R <sub>S</sub>         | Internal series termination without calibration (25-Ω setting) | V <sub>CCIO</sub> = 1.2 V         | ±35                  | ±35   | ±50             | ±50    | %    |

-  You typically use the interactive Excel-based Early Power Estimator before designing the FPGA to get a magnitude estimate of the device power. The Quartus II PowerPlay Power Analyzer provides better quality estimates based on the specifics of the design after you complete place-and-route. The PowerPlay Power Analyzer can apply a combination of user-entered, simulation-derived, and estimated signal activities that, when combined with detailed circuit models, yields very accurate power estimates.
-  For more information about power estimation tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter in the *Quartus II Handbook*.

## Switching Characteristics

This section provides performance characteristics of the Stratix V core and periphery blocks.

These characteristics can be designated as Preliminary or Final.

- Preliminary characteristics are created using simulation results, process data, and other known parameters. The title of these tables show the designation as “Preliminary.”
- Final numbers are based on actual silicon characterization and testing. The numbers reflect the actual performance of the device under worst-case silicon process, voltage, and junction temperature conditions. There are no designations on finalized tables.

### Transceiver Performance Specifications

This section describes transceiver performance specifications.

Table 23 lists the Stratix V GX and GS transceiver specifications.

**Table 23. Transceiver Specifications for Stratix V GX and GS Devices <sup>(1)</sup> (Part 1 of 7)**

| Symbol/<br>Description   | Conditions  | Transceiver Speed<br>Grade 1  |     |     | Transceiver Speed<br>Grade 2 |     |     | Transceiver Speed<br>Grade 3 |     |     | Unit |
|--|---|---|-----|-----|------------------------------|-----|-----|------------------------------|-----|-----|------|
|  |   | Min   | Typ | Max | Min                          | Typ | Max | Min                          | Typ | Max |      |
| Reference Clock  |   |   |     |     |                              |     |     |                              |     |     |      |
| Supported I/O<br>Standards                                     | Dedicated<br>reference<br>clock pin                               | 1.2-V PCML, 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, Differential LVPECL, LVDS, and HCSL |     |     |                              |     |     |                              |     |     |      |
|  | RX reference<br>clock pin   | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS                                |     |     |                              |     |     |                              |     |     |      |
| Input Reference<br>Clock Frequency<br>(CMU PLL) <sup>(8)</sup> | —   | 40  | —   | 710 | 40                           | —   | 710 | 40                           | —   | 710 | MHz  |
| Input Reference<br>Clock Frequency<br>(ATX PLL) <sup>(8)</sup> | —   | 100   | —   | 710 | 100                          | —   | 710 | 100                          | —   | 710 | MHz  |
| Rise time  | Measure at<br>±60 mV of<br>differential<br>signal <sup>(26)</sup> | —   | —   | 400 | —                            | —   | 400 | —                            | —   | 400 | ps   |
| Fall time  | Measure at<br>±60 mV of<br>differential<br>signal <sup>(26)</sup> | —   | —   | 400 | —                            | —   | 400 | —                            | —   | 400 |      |
| Duty cycle   | —   | 45  | —   | 55  | 45                           | —   | 55  | 45                           | —   | 55  | %    |
| Spread-spectrum<br>modulating clock<br>frequency               | PCI Express®<br>(PCIe®)   | 30  | —   | 33  | 30                           | —   | 33  | 30                           | —   | 33  | kHz  |

**Table 23. Transceiver Specifications for Stratix V GX and GS Devices <sup>(1)</sup> (Part 5 of 7)**

| Symbol/<br>Description  | Conditions   | Transceiver Speed<br>Grade 1 |                     |       | Transceiver Speed<br>Grade 2 |                     |       | Transceiver Speed<br>Grade 3 |                     |                                     | Unit     |
|---|--|------------------------------|---------------------|-------|------------------------------|---------------------|-------|------------------------------|---------------------|-------------------------------------|----------|
|   |  | Min                          | Typ                 | Max   | Min                          | Typ                 | Max   | Min                          | Typ                 | Max                                 |          |
| Programmable<br>DC gain   | DC Gain<br>Setting = 0                                     | —                            | 0                   | —     | —                            | 0                   | —     | —                            | 0                   | —                                   | dB       |
|   | DC Gain<br>Setting = 1                                     | —                            | 2                   | —     | —                            | 2                   | —     | —                            | 2                   | —                                   | dB       |
|   | DC Gain<br>Setting = 2                                     | —                            | 4                   | —     | —                            | 4                   | —     | —                            | 4                   | —                                   | dB       |
|   | DC Gain<br>Setting = 3                                     | —                            | 6                   | —     | —                            | 6                   | —     | —                            | 6                   | —                                   | dB       |
|   | DC Gain<br>Setting = 4                                     | —                            | 8                   | —     | —                            | 8                   | —     | —                            | 8                   | —                                   | dB       |
| <b>Transmitter</b>  |  |                              |                     |       |                              |                     |       |                              |                     |                                     |          |
| Supported I/O<br>Standards  | —  | 1.4-V and 1.5-V PCML         |                     |       |                              |                     |       |                              |                     |                                     |          |
| Data rate<br>(Standard PCS)   | —  | 600                          | —                   | 12200 | 600                          | —                   | 12200 | 600                          | —                   | 8500/<br>10312.5<br><sup>(24)</sup> | Mbps     |
| Data rate<br>(10G PCS)  | —  | 600                          | —                   | 14100 | 600                          | —                   | 12500 | 600                          | —                   | 8500/<br>10312.5<br><sup>(24)</sup> | Mbps     |
| Differential on-<br>chip termination<br>resistors                     | 85- $\Omega$<br>setting                                    | —                            | 85 $\pm$<br>20%     | —     | —                            | 85 $\pm$<br>20%     | —     | —                            | 85 $\pm$<br>20%     | —                                   | $\Omega$ |
|   | 100- $\Omega$<br>setting                                   | —                            | 100<br>$\pm$<br>20% | —     | —                            | 100<br>$\pm$<br>20% | —     | —                            | 100<br>$\pm$<br>20% | —                                   | $\Omega$ |
|   | 120- $\Omega$<br>setting                                   | —                            | 120<br>$\pm$<br>20% | —     | —                            | 120<br>$\pm$<br>20% | —     | —                            | 120<br>$\pm$<br>20% | —                                   | $\Omega$ |
|   | 150- $\Omega$<br>setting                                   | —                            | 150<br>$\pm$<br>20% | —     | —                            | 150<br>$\pm$<br>20% | —     | —                            | 150<br>$\pm$<br>20% | —                                   | $\Omega$ |
| V <sub>OCM</sub> (AC<br>coupled)                                      | 0.65-V<br>setting  | —                            | 650                 | —     | —                            | 650                 | —     | —                            | 650                 | —                                   | mV       |
| V <sub>OCM</sub> (DC<br>coupled)                                      | —  | —                            | 650                 | —     | —                            | 650                 | —     | —                            | 650                 | —                                   | mV       |
| Rise time <sup>(7)</sup>  | 20% to 80%   | 30                           | —                   | 160   | 30                           | —                   | 160   | 30                           | —                   | 160                                 | ps       |
| Fall time <sup>(7)</sup>  | 80% to 20%   | 30                           | —                   | 160   | 30                           | —                   | 160   | 30                           | —                   | 160                                 | ps       |
| Intra-differential<br>pair skew                                       | Tx V <sub>CM</sub> =<br>0.5 V and<br>slew rate of<br>15 ps | —                            | —                   | 15    | —                            | —                   | 15    | —                            | —                   | 15                                  | ps       |
| Intra-transceiver<br>block transmitter<br>channel-to-<br>channel skew | x6 PMA<br>bonded mode                                      | —                            | —                   | 120   | —                            | —                   | 120   | —                            | —                   | 120                                 | ps       |

**Table 23. Transceiver Specifications for Stratix V GX and GS Devices <sup>(1)</sup> (Part 6 of 7)**

| Symbol/<br>Description  | Conditions                                   | Transceiver Speed<br>Grade 1 |     |                               | Transceiver Speed<br>Grade 2 |     |                               | Transceiver Speed<br>Grade 3 |     |                                     | Unit |
|---|--|------------------------------|-----|-------------------------------|------------------------------|-----|-------------------------------|------------------------------|-----|-------------------------------------|------|
|   |  | Min                          | Typ | Max                           | Min                          | Typ | Max                           | Min                          | Typ | Max                                 |      |
| Inter-transceiver<br>block transmitter<br>channel-to-<br>channel skew | xN PMA<br>bonded mode                        | —                            | —   | 500                           | —                            | —   | 500                           | —                            | —   | 500                                 | ps   |
| <b>CMU PLL</b>  |  |                              |     |                               |                              |     |                               |                              |     |                                     |      |
| Supported Data<br>Range   | —  | 600                          | —   | 12500                         | 600                          | —   | 12500                         | 600                          | —   | 8500/<br>10312.5<br><sup>(24)</sup> | Mbps |
| t <sub>pll_powerdown</sub> <sup>(15)</sup>                            | —  | 1                            | —   | —                             | 1                            | —   | —                             | 1                            | —   | —                                   | μs   |
| t <sub>pll_lock</sub> <sup>(16)</sup>                                 | —  | —                            | —   | 10                            | —                            | —   | 10                            | —                            | —   | 10                                  | μs   |
| <b>ATX PLL</b>  |  |                              |     |                               |                              |     |                               |                              |     |                                     |      |
| Supported Data<br>Rate Range  | VCO<br>post-divider<br>L=2                   | 8000                         | —   | 14100                         | 8000                         | —   | 12500                         | 8000                         | —   | 8500/<br>10312.5<br><sup>(24)</sup> | Mbps |
|   | L=4  | 4000                         | —   | 7050                          | 4000                         | —   | 6600                          | 4000                         | —   | 6600                                | Mbps |
|   | L=8  | 2000                         | —   | 3525                          | 2000                         | —   | 3300                          | 2000                         | —   | 3300                                | Mbps |
|   | L=8,<br>Local/Central<br>Clock Divider<br>=2 | 1000                         | —   | 1762.5                        | 1000                         | —   | 1762.5                        | 1000                         | —   | 1762.5                              | Mbps |
| t <sub>pll_powerdown</sub> <sup>(15)</sup>                            | —  | 1                            | —   | —                             | 1                            | —   | —                             | 1                            | —   | —                                   | μs   |
| t <sub>pll_lock</sub> <sup>(16)</sup>                                 | —  | —                            | —   | 10                            | —                            | —   | 10                            | —                            | —   | 10                                  | μs   |
| <b>fPLL</b>   |  |                              |     |                               |                              |     |                               |                              |     |                                     |      |
| Supported Data<br>Range   | —  | 600                          | —   | 3250/<br>3125 <sup>(25)</sup> | 600                          | —   | 3250/<br>3125 <sup>(25)</sup> | 600                          | —   | 3250/<br>3125 <sup>(25)</sup>       | Mbps |
| t <sub>pll_powerdown</sub> <sup>(15)</sup>                            | —  | 1                            | —   | —                             | 1                            | —   | —                             | 1                            | —   | —                                   | μs   |



Table 26 shows the approximate maximum data rate using the 10G PCS.

**Table 26. Stratix V 10G PCS Approximate Maximum Data Rate <sup>(1)</sup>**

| Mode <sup>(2)</sup> | Transceiver Speed Grade | PMA Width                             | 64           | 40    | 40    | 40   | 32       | 32    |
|---------------------|-------------------------|---------------------------------------|--------------|-------|-------|------|----------|-------|
|                     |                         | PCS Width                             | 64           | 66/67 | 50    | 40   | 64/66/67 | 32    |
| FIFO or Register    | 1                       | C1, C2, C2L, I2, I2L core speed grade | 14.1         | 14.1  | 10.69 | 14.1 | 13.6     | 13.6  |
|                     | 2                       | C1, C2, C2L, I2, I2L core speed grade | 12.5         | 12.5  | 10.69 | 12.5 | 12.5     | 12.5  |
|                     |                         | C3, I3, I3L core speed grade          | 12.5         | 12.5  | 10.69 | 12.5 | 10.88    | 10.88 |
|                     | 3                       | C1, C2, C2L, I2, I2L core speed grade | 8.5 Gbps     |       |       |      |          |       |
|                     |                         | C3, I3, I3L core speed grade          |              |       |       |      |          |       |
|                     |                         | C4, I4 core speed grade               |              |       |       |      |          |       |
|                     |                         | I3YY core speed grade                 | 10.3125 Gbps |       |       |      |          |       |

**Notes to Table 26:**

- (1) The maximum data rate is in Gbps.
- (2) The Phase Compensation FIFO can be configured in FIFO mode or register mode. In the FIFO mode, the pointers are not fixed, and the latency can vary. In the register mode the pointers are fixed for low latency.

**Table 28. Transceiver Specifications for Stratix V GT Devices (Part 4 of 5) <sup>(1)</sup>**

| Symbol/<br>Description   | Conditions                                   | Transceiver<br>Speed Grade 2 |     |                                | Transceiver<br>Speed Grade 3 |     |                                | Unit |
|--|--|------------------------------|-----|--------------------------------|------------------------------|-----|--------------------------------|------|
|  |  | Min                          | Typ | Max                            | Min                          | Typ | Max                            |      |
| Data rate  | GT channels                                  | 19,600                       | —   | 28,050                         | 19,600                       | —   | 25,780                         | Mbps |
| Differential on-chip<br>termination resistors                      | GT channels                                  | —                            | 100 | —                              | —                            | 100 | —                              | Ω    |
|  | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| V <sub>OCM</sub> (AC coupled)                                      | GT channels                                  | —                            | 500 | —                              | —                            | 500 | —                              | mV   |
|  | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| Rise/Fall time   | GT channels                                  | —                            | 15  | —                              | —                            | 15  | —                              | ps   |
|  | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| Intra-differential pair<br>skew                                    | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| Intra-transceiver block<br>transmitter channel-to-<br>channel skew | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| Inter-transceiver block<br>transmitter channel-to-<br>channel skew | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| CMU PLL  |  |                              |     |                                |                              |     |                                |      |
| Supported Data Range   | —  | 600                          | —   | 12500                          | 600                          | —   | 8500                           | Mbps |
| t <sub>pll_powerdown</sub> <sup>(13)</sup>                         | —  | 1                            | —   | —                              | 1                            | —   | —                              | μs   |
| t <sub>pll_lock</sub> <sup>(14)</sup>                              | —  | —                            | —   | 10                             | —                            | —   | 10                             | μs   |
| ATX PLL  |  |                              |     |                                |                              |     |                                |      |
| Supported Data Rate<br>Range for GX Channels                       | VCO post-<br>divider L=2                     | 8000                         | —   | 12500                          | 8000                         | —   | 8500                           | Mbps |
|  | L=4  | 4000                         | —   | 6600                           | 4000                         | —   | 6600                           | Mbps |
|  | L=8  | 2000                         | —   | 3300                           | 2000                         | —   | 3300                           | Mbps |
|  | L=8,<br>Local/Central<br>Clock Divider<br>=2 | 1000                         | —   | 1762.5                         | 1000                         | —   | 1762.5                         | Mbps |
| Supported Data Rate<br>Range for GT Channels                       | VCO post-<br>divider L=2                     | 9800                         | —   | 14025                          | 9800                         | —   | 12890                          | Mbps |
| t <sub>pll_powerdown</sub> <sup>(13)</sup>                         | —  | 1                            | —   | —                              | 1                            | —   | —                              | μs   |
| t <sub>pll_lock</sub> <sup>(14)</sup>                              | —  | —                            | —   | 10                             | —                            | —   | 10                             | μs   |
| fPLL   |  |                              |     |                                |                              |     |                                |      |
| Supported Data Range   | —  | 600                          | —   | 3250/<br>3.125 <sup>(23)</sup> | 600                          | —   | 3250/<br>3.125 <sup>(23)</sup> | Mbps |
| t <sub>pll_powerdown</sub> <sup>(13)</sup>                         | —  | 1                            | —   | —                              | 1                            | —   | —                              | μs   |

- XFI
- ASI
- HiGig/HiGig+
- HiGig2/HiGig2+
- Serial Data Converter (SDC)
- GPON
- SDI
- SONET
- Fibre Channel (FC)
- PCIe
- QPI
- SFF-8431

Download the Stratix V Characterization Report Tool to view the characterization report summary for these protocols.

## Core Performance Specifications

This section describes the clock tree, phase-locked loop (PLL), digital signal processing (DSP), memory blocks, configuration, and JTAG specifications.

### Clock Tree Specifications

Table 30 lists the clock tree specifications for Stratix V devices.

**Table 30. Clock Tree Performance for Stratix V Devices <sup>(1)</sup>**

| Symbol                    | Performance              |                       |        | Unit |
|---------------------------|--------------------------|-----------------------|--------|------|
|                           | C1, C2, C2L, I2, and I2L | C3, I3, I3L, and I3YY | C4, I4 |      |
| Global and Regional Clock | 717                      | 650                   | 580    | MHz  |
| Periphery Clock           | 550                      | 500                   | 500    | MHz  |

**Note to Table 30:**

(1) The Stratix V ES devices are limited to 600 MHz core clock tree performance.

**Table 32. Block Performance Specifications for Stratix V DSP Devices (Part 2 of 2)**

| Mode                   | Peformance |         |         |     |               |     |     | Unit |
|------------------------|------------|---------|---------|-----|---------------|-----|-----|------|
|                        | C1         | C2, C2L | I2, I2L | C3  | I3, I3L, I3YY | C4  | I4  |      |
| Modes using Three DSPs |            |         |         |     |               |     |     |      |
| One complex 18 x 25    | 425        | 425     | 415     | 340 | 340           | 275 | 265 | MHz  |
| Modes using Four DSPs  |            |         |         |     |               |     |     |      |
| One complex 27 x 27    | 465        | 465     | 465     | 380 | 380           | 300 | 290 | MHz  |

### Memory Block Specifications

Table 33 lists the Stratix V memory block specifications.

**Table 33. Memory Block Performance Specifications for Stratix V Devices <sup>(1)</sup>, <sup>(2)</sup> (Part 1 of 2)**

| Memory | Mode                                       | Resources Used |        | Performance |         |     |     |         |               |     | Unit |
|--------|--|----------------|--------|-------------|---------|-----|-----|---------|---------------|-----|------|
|        |  | ALUTs          | Memory | C1          | C2, C2L | C3  | C4  | I2, I2L | I3, I3L, I3YY | I4  |      |
| MLAB   | Single port, all supported widths          | 0              | 1      | 450         | 450     | 400 | 315 | 450     | 400           | 315 | MHz  |
|        | Simple dual-port, x32/x64 depth            | 0              | 1      | 450         | 450     | 400 | 315 | 450     | 400           | 315 | MHz  |
|        | Simple dual-port, x16 depth <sup>(3)</sup> | 0              | 1      | 675         | 675     | 533 | 400 | 675     | 533           | 400 | MHz  |
|        | ROM, all supported widths                  | 0              | 1      | 600         | 600     | 500 | 450 | 600     | 500           | 450 | MHz  |

## Periphery Performance

This section describes periphery performance, including high-speed I/O and external memory interface.

I/O performance supports several system interfaces, such as the **LVDS** high-speed I/O interface, external memory interface, and the **PCI/PCI-X** bus interface.

General-purpose I/O standards such as 3.3-, 2.5-, 1.8-, and 1.5-**LVTTL/LVCMOS** are capable of a typical 167 MHz and 1.2-**LVCMOS** at 100 MHz interfacing frequency with a 10 pF load.



The actual achievable frequency depends on design- and system-specific factors. Ensure proper timing closure in your design and perform HSPICE/IBIS simulations based on your specific design and system setup to determine the maximum achievable frequency in your system.

### High-Speed I/O Specification

Table 36 lists high-speed I/O timing for Stratix V devices.

**Table 36. High-Speed I/O Specifications for Stratix V Devices <sup>(1)</sup>, <sup>(2)</sup> (Part 1 of 4)**

| Symbol   | Conditions   | C1  |     |     | C2, C2L, I2, I2L |     |     | C3, I3, I3L, I3YY |     |                    | C4,I4 |     |                    | Unit |
|--|--|-----|-----|-----|------------------|-----|-----|-------------------|-----|--------------------|-------|-----|--------------------|------|
|  |  | Min | Typ | Max | Min              | Typ | Max | Min               | Typ | Max                | Min   | Typ | Max                |      |
| $f_{\text{HCLK\_in}}$ (input clock frequency)<br>True Differential I/O Standards           | Clock boost factor<br>$W = 1$ to 40 <sup>(4)</sup> | 5   | —   | 800 | 5                | —   | 800 | 5                 | —   | 625                | 5     | —   | 525                | MHz  |
| $f_{\text{HCLK\_in}}$ (input clock frequency)<br>Single Ended I/O Standards <sup>(3)</sup> | Clock boost factor<br>$W = 1$ to 40 <sup>(4)</sup> | 5   | —   | 800 | 5                | —   | 800 | 5                 | —   | 625                | 5     | —   | 525                | MHz  |
| $f_{\text{HCLK\_in}}$ (input clock frequency)<br>Single Ended I/O Standards                | Clock boost factor<br>$W = 1$ to 40 <sup>(4)</sup> | 5   | —   | 520 | 5                | —   | 520 | 5                 | —   | 420                | 5     | —   | 420                | MHz  |
| $f_{\text{HCLK\_OUT}}$ (output clock frequency)  | —  | 5   | —   | 800 | 5                | —   | 800 | 5                 | —   | 625 <sup>(5)</sup> | 5     | —   | 525 <sup>(5)</sup> | MHz  |

**Table 36. High-Speed I/O Specifications for Stratix V Devices <sup>(1), (2)</sup> (Part 2 of 4)**

| Symbol   | Conditions  | C1  |     |      | C2, C2L, I2, I2L |     |      | C3, I3, I3L, I3YY |     |      | C4,I4 |     |      | Unit |
|--|---|-----|-----|------|------------------|-----|------|-------------------|-----|------|-------|-----|------|------|
|  |   | Min | Typ | Max  | Min              | Typ | Max  | Min               | Typ | Max  | Min   | Typ | Max  |      |
| Transmitter  |   |     |     |      |                  |     |      |                   |     |      |       |     |      |      |
| True Differential I/O Standards - f <sub>HSDR</sub> (data rate)  | SERDES factor J = 3 to 10 <sup>(9), (11), (12), (13), (14), (15), (16)</sup>  | (6) | —   | 1600 | (6)              | —   | 1434 | (6)               | —   | 1250 | (6)   | —   | 1050 | Mbps |
|  | SERDES factor J ≥ 4<br><br>LVDS TX with DPA <sup>(12), (14), (15), (16)</sup> | (6) | —   | 1600 | (6)              | —   | 1600 | (6)               | —   | 1600 | (6)   | —   | 1250 | Mbps |
|  | SERDES factor J = 2,<br>uses DDR Registers                                    | (6) | —   | (7)  | (6)              | —   | (7)  | (6)               | —   | (7)  | (6)   | —   | (7)  | Mbps |
|  | SERDES factor J = 1,<br>uses SDR Register                                     | (6) | —   | (7)  | (6)              | —   | (7)  | (6)               | —   | (7)  | (6)   | —   | (7)  | Mbps |
| Emulated Differential I/O Standards with Three External Output Resistor Networks - f <sub>HSDR</sub> (data rate) <sup>(10)</sup> | SERDES factor J = 4 to 10 <sup>(17)</sup>                                     | (6) | —   | 1100 | (6)              | —   | 1100 | (6)               | —   | 840  | (6)   | —   | 840  | Mbps |
| t <sub>x Jitter</sub> - True Differential I/O Standards  | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps                               | —   | —   | 160  | —                | —   | 160  | —                 | —   | 160  | —     | —   | 160  | ps   |
|  | Total Jitter for Data Rate < 600 Mbps   | —   | —   | 0.1  | —                | —   | 0.1  | —                 | —   | 0.1  | —     | —   | 0.1  | UI   |
| t <sub>x Jitter</sub> - Emulated Differential I/O Standards with Three External Output Resistor Network                          | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps                               | —   | —   | 300  | —                | —   | 300  | —                 | —   | 300  | —     | —   | 325  | ps   |
|  | Total Jitter for Data Rate < 600 Mbps   | —   | —   | 0.2  | —                | —   | 0.2  | —                 | —   | 0.2  | —     | —   | 0.25 | UI   |

**Table 47. Uncompressed .rbf Sizes for Stratix V Devices**

| Family                     | Device | Package | Configuration .rbf Size (bits) | IOCSR .rbf Size (bits) <sup>(4), (5)</sup> |
|----------------------------|--------|---------|--------------------------------|--|
| Stratix V E <sup>(1)</sup> | 5SEE9  | —       | 342,742,976                    | 700,888                                    |
|                            | 5SEEB  | —       | 342,742,976                    | 700,888                                    |

**Notes to Table 47:**

- (1) Stratix V E devices do not have PCI Express® (PCIe®) hard IP. Stratix V E devices do not support the CvP configuration scheme.
- (2) 36-transceiver devices.
- (3) 24-transceiver devices.
- (4) File size for the periphery image.
- (5) The IOCSR .rbf size is specifically for the CvP feature.

Use the data in Table 47 to estimate the file size before design compilation. Different configuration file formats, such as a hexadecimal (.hex) or tabular text file (.tff) format, have different file sizes. For the different types of configuration file and file sizes, refer to the Quartus II software. However, for a specific version of the Quartus II software, any design targeted for the same device has the same uncompressed configuration file size. If you are using compression, the file size can vary after each compilation because the compression ratio depends on your design.



For more information about setting device configuration options, refer to *Configuration, Design Security, and Remote System Upgrades in Stratix V Devices*. For creating configuration files, refer to the *Quartus II Help*.

Table 48 lists the minimum configuration time estimates for Stratix V devices.

**Table 48. Minimum Configuration Time Estimation for Stratix V Devices**

| Variant | Member Code | Active Serial <sup>(1)</sup> |            |                     | Fast Passive Parallel <sup>(2)</sup> |            |                     |
|---------|-------------|------------------------------|------------|---------------------|--------------------------------------|------------|---------------------|
|         |             | Width                        | DCLK (MHz) | Min Config Time (s) | Width                                | DCLK (MHz) | Min Config Time (s) |
| GX      | A3          | 4                            | 100        | 0.534               | 32                                   | 100        | 0.067               |
|         |             | 4                            | 100        | 0.344               | 32                                   | 100        | 0.043               |
|         | A4          | 4                            | 100        | 0.534               | 32                                   | 100        | 0.067               |
|         | A5          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |
|         | A7          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |
|         | A9          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | AB          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | B5          | 4                            | 100        | 0.676               | 32                                   | 100        | 0.085               |
|         | B6          | 4                            | 100        | 0.676               | 32                                   | 100        | 0.085               |
|         | B9          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | BB          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
| GT      | C5          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |
|         | C7          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |

**Table 49. DCLK-to-DATA[] Ratio <sup>(1)</sup> (Part 2 of 2)**

| Configuration Scheme | Decompression | Design Security | DCLK-to-DATA[] Ratio |
|----------------------|---------------|-----------------|----------------------|
| FPP ×32              | Disabled      | Disabled        | 1                    |
|                      | Disabled      | Enabled         | 4                    |
|                      | Enabled       | Disabled        | 8                    |
|                      | Enabled       | Enabled         | 8                    |

**Note to Table 49:**

- (1) Depending on the DCLK-to-DATA[] ratio, the host must send a DCLK frequency that is r times the data rate in bytes per second (Bps), or words per second (Wps). For example, in FPP ×16 when the DCLK-to-DATA[] ratio is 2, the DCLK frequency must be 2 times the data rate in Wps. Stratix V devices use the additional clock cycles to decrypt and decompress the configuration data.



If the DCLK-to-DATA[] ratio is greater than 1, at the end of configuration, you can only stop the DCLK (DCLK-to-DATA[] ratio – 1) clock cycles after the last data is latched into the Stratix V device.

Figure 11 shows the configuration interface connections between the Stratix V device and a MAX II or MAX V device for single device configuration.

**Figure 11. Single Device FPP Configuration Using an External Host****Notes to Figure 11:**

- (1) Connect the resistor to a supply that provides an acceptable input signal for the Stratix V device.  $V_{CCPGM}$  must be high enough to meet the  $V_{IH}$  specification of the I/O on the device and the external host. Altera recommends powering up all configuration system I/Os with  $V_{CCPGM}$ .
- (2) You can leave the nCEO pin unconnected or use it as a user I/O pin when it does not feed another device's nCE pin.
- (3) The MSEL pin settings vary for different data width, configuration voltage standards, and POR delay. To connect MSEL, refer to the MSEL Pin Settings section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.
- (4) If you use FPP ×8, use DATA [7..0]. If you use FPP ×16, use DATA [15..0].



Table 51 lists the timing parameters for Stratix V devices for FPP configuration when the DCLK-to-DATA [ ] ratio is more than 1.

**Table 51. FPP Timing Parameters for Stratix V Devices When the DCLK-to-DATA[ ] Ratio is >1 <sup>(1)</sup>**

| Symbol                     | Parameter   | Minimum   | Maximum              | Units   |
|----------------------------|---|---|----------------------|---------|
| $t_{CF2CD}$                | nCONFIG low to CONF_DONE low                      | —   | 600                  | ns      |
| $t_{CF2ST0}$               | nCONFIG low to nSTATUS low                        | —   | 600                  | ns      |
| $t_{CFG}$                  | nCONFIG low pulse width                           | 2   | —                    | $\mu$ s |
| $t_{STATUS}$               | nSTATUS low pulse width                           | 268   | 1,506 <sup>(2)</sup> | $\mu$ s |
| $t_{CF2ST1}$               | nCONFIG high to nSTATUS high                      | —   | 1,506 <sup>(2)</sup> | $\mu$ s |
| $t_{CF2CK}$ <sup>(5)</sup> | nCONFIG high to first rising edge on DCLK         | 1,506   | —                    | $\mu$ s |
| $t_{ST2CK}$ <sup>(5)</sup> | nSTATUS high to first rising edge of DCLK         | 2   | —                    | $\mu$ s |
| $t_{DSU}$                  | DATA [ ] setup time before rising edge on DCLK    | 5.5   | —                    | ns      |
| $t_{DH}$                   | DATA [ ] hold time after rising edge on DCLK      | $N-1/f_{DCLK}$ <sup>(5)</sup>                                   | —                    | s       |
| $t_{CH}$                   | DCLK high time                                    | $0.45 \times 1/f_{MAX}$   | —                    | s       |
| $t_{CL}$                   | DCLK low time                                     | $0.45 \times 1/f_{MAX}$   | —                    | s       |
| $t_{CLK}$                  | DCLK period                                       | $1/f_{MAX}$   | —                    | s       |
| $f_{MAX}$                  | DCLK frequency (FPP $\times 8/\times 16$ )        | —   | 125                  | MHz     |
|                            | DCLK frequency (FPP $\times 32$ )                 | —   | 100                  | MHz     |
| $t_R$                      | Input rise time                                   | —   | 40                   | ns      |
| $t_F$                      | Input fall time                                   | —   | 40                   | ns      |
| $t_{CD2UM}$                | CONF_DONE high to user mode <sup>(3)</sup>        | 175   | 437                  | $\mu$ s |
| $t_{CD2CU}$                | CONF_DONE high to CLKUSR enabled                  | $4 \times$ maximum DCLK period                                  | —                    | —       |
| $t_{CD2UMC}$               | CONF_DONE high to user mode with CLKUSR option on | $t_{CD2CU} + (8576 \times \text{CLKUSR period})$ <sup>(4)</sup> | —                    | —       |

**Notes to Table 51:**

- (1) Use these timing parameters when you use the decompression and design security features.
- (2) You can obtain this value if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (3) The minimum and maximum numbers apply only if you use the internal oscillator as the clock source for initializing the device.
- (4) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the Initialization section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.
- (5) N is the DCLK-to-DATA ratio and  $f_{DCLK}$  is the DCLK frequency the system is operating.
- (6) If nSTATUS is monitored, follow the  $t_{ST2CK}$  specification. If nSTATUS is not monitored, follow the  $t_{CF2CK}$  specification.

## Active Serial Configuration Timing

Table 52 lists the DCLK frequency specification in the AS configuration scheme.

**Table 52. DCLK Frequency Specification in the AS Configuration Scheme <sup>(1), (2)</sup>**

| Minimum | Typical | Maximum | Unit |
|---------|---------|---------|------|
| 5.3     | 7.9     | 12.5    | MHz  |
| 10.6    | 15.7    | 25.0    | MHz  |
| 21.3    | 31.4    | 50.0    | MHz  |
| 42.6    | 62.9    | 100.0   | MHz  |

**Notes to Table 52:**

- (1) This applies to the DCLK frequency specification when using the internal oscillator as the configuration clock source.
- (2) The AS multi-device configuration scheme does not support DCLK frequency of 100 MHz.

Figure 14 shows the single-device configuration setup for an AS ×1 mode.

**Figure 14. AS Configuration Timing**



**Notes to Figure 14:**

- (1) If you are using AS ×4 mode, this signal represents the AS\_DATA [3 : 0] and EPCQ sends in 4-bits of data for each DCLK cycle.
- (2) The initialization clock can be from internal oscillator or CLKUSR pin.
- (3) After the option bit to enable the INIT\_DONE pin is configured into the device, the INIT\_DONE goes low.

Table 53 lists the timing parameters for AS ×1 and AS ×4 configurations in Stratix V devices.

**Table 53. AS Timing Parameters for AS ×1 and AS ×4 Configurations in Stratix V Devices <sup>(1), (2)</sup> (Part 1 of 2)**

| Symbol   | Parameter                                   | Minimum | Maximum | Units |
|----------|---|---------|---------|-------|
| $t_{CO}$ | DCLK falling edge to AS_DATA0/ASDO output   | —       | 2       | ns    |
| $t_{SU}$ | Data setup time before falling edge on DCLK | 1.5     | —       | ns    |
| $t_H$    | Data hold time after falling edge on DCLK   | 0       | —       | ns    |

**Table 58. IOE Programmable Delay for Stratix V Devices (Part 2 of 2)**

| Parameter<br>(1) | Available<br>Settings | Min<br>Offset<br>(2) | Fast Model |            | Slow Model |       |       |       |       |             |       |      |
|------------------|-----------------------|----------------------|------------|------------|------------|-------|-------|-------|-------|-------------|-------|------|
|                  |                       |                      | Industrial | Commercial | C1         | C2    | C3    | C4    | I2    | I3,<br>I3YY | I4    | Unit |
| D3               | 8                     | 0                    | 1.587      | 1.699      | 2.793      | 2.793 | 2.992 | 3.192 | 2.811 | 3.047       | 3.257 | ns   |
| D4               | 64                    | 0                    | 0.464      | 0.492      | 0.838      | 0.838 | 0.924 | 1.011 | 0.843 | 0.920       | 1.006 | ns   |
| D5               | 64                    | 0                    | 0.464      | 0.493      | 0.838      | 0.838 | 0.924 | 1.011 | 0.844 | 0.921       | 1.006 | ns   |
| D6               | 32                    | 0                    | 0.229      | 0.244      | 0.415      | 0.415 | 0.458 | 0.503 | 0.418 | 0.456       | 0.499 | ns   |

**Notes to Table 58:**

- (1) You can set this value in the Quartus II software by selecting **D1**, **D2**, **D3**, **D5**, and **D6** in the **Assignment Name** column of **Assignment Editor**.
- (2) Minimum offset does not include the intrinsic delay.

## Programmable Output Buffer Delay

Table 59 lists the delay chain settings that control the rising and falling edge delays of the output buffer. The default delay is 0 ps.

**Table 59. Programmable Output Buffer Delay for Stratix V Devices (1)**

| Symbol              | Parameter                        | Typical     | Unit |
|---------------------|----------------------------------|-------------|------|
| D <sub>OUTBUF</sub> | Rising and/or falling edge delay | 0 (default) | ps   |
|                     |                                  | 25          | ps   |
|                     |                                  | 50          | ps   |
|                     |                                  | 75          | ps   |

**Note to Table 59:**

- (1) You can set the programmable output buffer delay in the Quartus II software by setting the **Output Buffer Delay Control** assignment to either positive, negative, or both edges, with the specific values stated here (in ps) for the **Output Buffer Delay** assignment.

## Glossary

Table 60 lists the glossary for this chapter.

**Table 60. Glossary (Part 1 of 4)**

| Letter | Subject              | Definitions   |
|--------|----------------------|---|
| A      | —                    | —   |
| B      |                      |   |
| C      |                      |   |
| D      | —                    | —   |
| E      | —                    | —   |
| F      | f <sub>HCLK</sub>    | Left and right PLL input clock frequency.   |
|        | f <sub>HSDR</sub>    | High-speed I/O block—Maximum and minimum <b>LVDS</b> data transfer rate (f <sub>HSDR</sub> = 1/TUI), non-DPA. |
|        | f <sub>HSDRDPA</sub> | High-speed I/O block—Maximum and minimum <b>LVDS</b> data transfer rate (f <sub>HSDRDPA</sub> = 1/TUI), DPA.  |

Table 60. Glossary (Part 3 of 4)

| Letter | Subject                                      | Definitions  |
|--------|--|--|
| S      | SW (sampling window)                         | <p>Timing Diagram—the period of time during which the data must be valid in order to capture it correctly. The setup and hold times determine the ideal strobe position within the sampling window, as shown:</p>  |
|        | Single-ended voltage referenced I/O standard | <p>The JEDEC standard for <b>SSTL</b> and <b>HSTL</b> I/O defines both the AC and DC input signal values. The AC values indicate the voltage levels at which the receiver must meet its timing specifications. The DC values indicate the voltage levels at which the final logic state of the receiver is unambiguously defined. After the receiver input has crossed the AC value, the receiver changes to the new logic state.</p> <p>The new logic state is then maintained as long as the input stays beyond the DC threshold. This approach is intended to provide predictable receiver timing in the presence of input waveform ringing:</p> <p><i>Single-Ended Voltage Referenced I/O Standard</i></p> |
| T      | $t_c$  | High-speed receiver and transmitter input and output clock period.   |
|        | TCCS (channel-to-channel-skew)               | The timing difference between the fastest and slowest output edges, including $t_{CO}$ variation and clock skew, across channels driven by the same PLL. The clock is included in the TCCS measurement (refer to the <i>Timing Diagram</i> figure under <b>SW</b> in this table).  |
|        | $t_{DUTY}$                                   | <p>High-speed I/O block—Duty cycle on the high-speed transmitter output clock.</p> <p><b>Timing Unit Interval (TUI)</b></p> <p>The timing budget allowed for skew, propagation delays, and the data sampling window. (TUI = <math>1/(\text{receiver input clock frequency multiplication factor}) = t_c/w</math>)</p>  |
|        | $t_{FALL}$                                   | Signal high-to-low transition time (80-20%)  |
|        | $t_{INCCJ}$                                  | Cycle-to-cycle jitter tolerance on the PLL clock input.  |
|        | $t_{OUTPJ\_IO}$                              | Period jitter on the general purpose I/O driven by a PLL.  |
|        | $t_{OUTPJ\_DC}$                              | Period jitter on the dedicated clock output driven by a PLL.   |
|        | $t_{RISE}$                                   | Signal low-to-high transition time (20-80%)  |
| U      | —  | —  |

**Table 60. Glossary (Part 4 of 4)**

| Letter   | Subject       | Definitions  |
|----------|---------------|--|
| <b>V</b> | $V_{CM(DC)}$  | DC common mode input voltage.  |
|          | $V_{ICM}$     | Input common mode voltage—The common mode of the differential signal at the receiver.  |
|          | $V_{ID}$      | Input differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the receiver.     |
|          | $V_{DIF(AC)}$ | AC differential input voltage—Minimum AC input differential voltage required for switching.  |
|          | $V_{DIF(DC)}$ | DC differential input voltage— Minimum DC input differential voltage required for switching.   |
|          | $V_{IH}$      | Voltage input high—The minimum positive voltage applied to the input which is accepted by the device as a logic high.  |
|          | $V_{IH(AC)}$  | High-level AC input voltage  |
|          | $V_{IH(DC)}$  | High-level DC input voltage  |
|          | $V_{IL}$      | Voltage input low—The maximum positive voltage applied to the input which is accepted by the device as a logic low.  |
|          | $V_{IL(AC)}$  | Low-level AC input voltage   |
|          | $V_{IL(DC)}$  | Low-level DC input voltage   |
|          | $V_{OCM}$     | Output common mode voltage—The common mode of the differential signal at the transmitter.  |
|          | $V_{OD}$      | Output differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the transmitter. |
|          | $V_{SWING}$   | Differential input voltage   |
|          | $V_X$         | Input differential cross point voltage   |
|          | $V_{OX}$      | Output differential cross point voltage  |
| <b>W</b> | W             | High-speed I/O block—clock boost factor  |
| <b>X</b> | —             | —  |
| <b>Y</b> |               |  |
| <b>Z</b> |               |  |